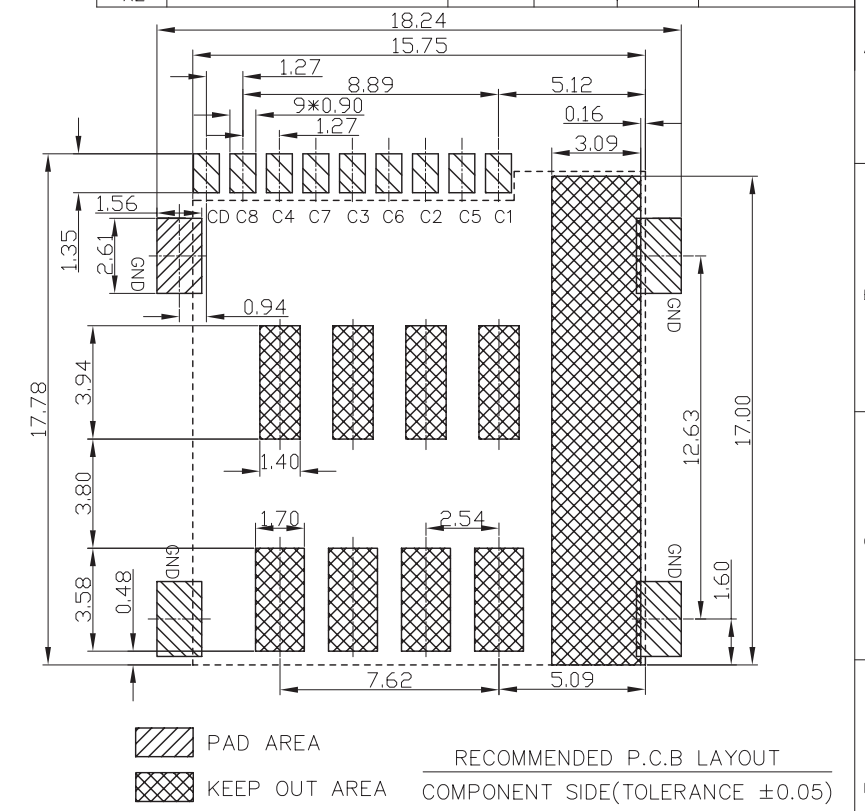
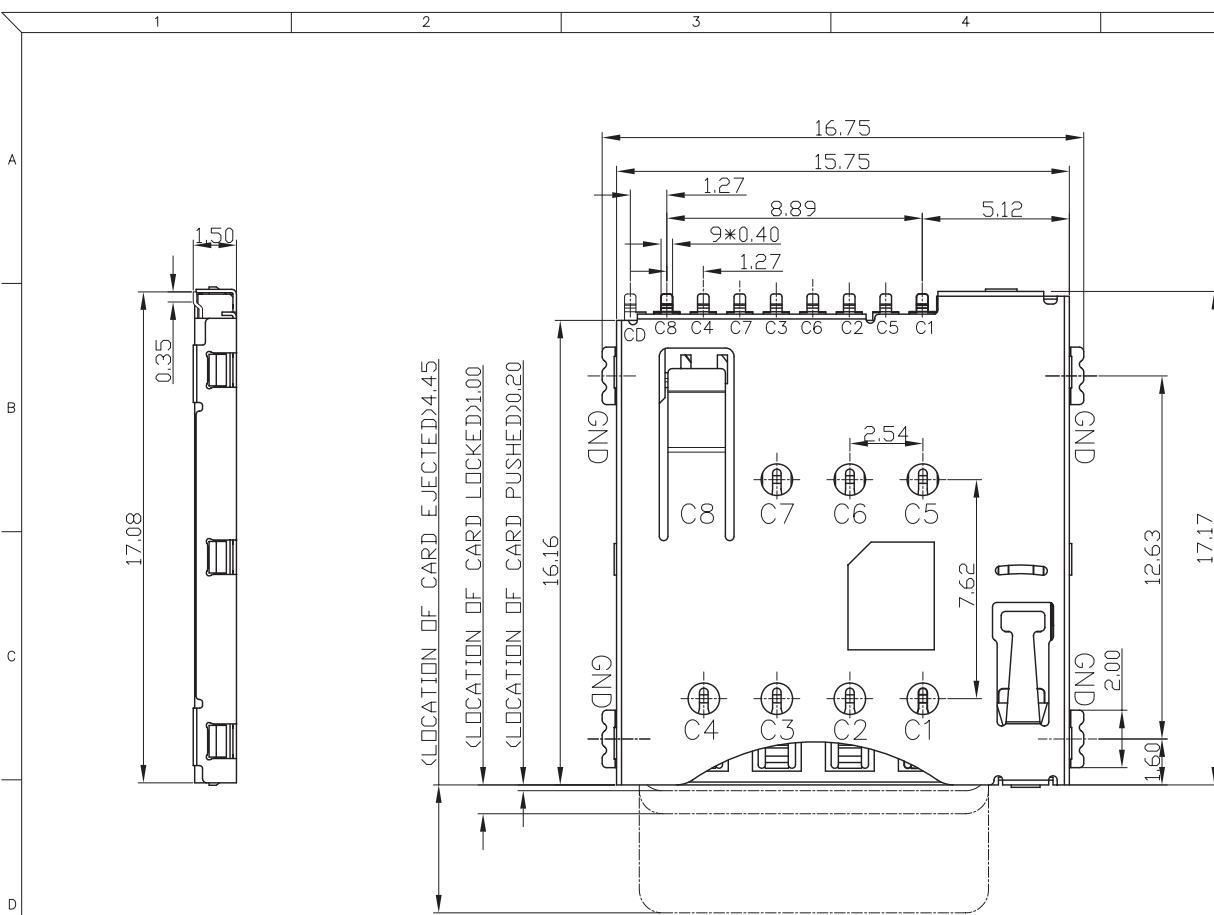


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



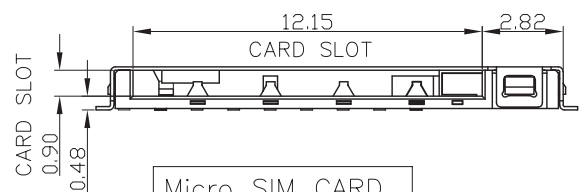
TECHNICAL CHARACTERISTICS

1.General Characteristics
 Dimensions: 15.75LX17.17WX1.50H mm
 Weight: Approx 0.4±0.1g
 Durability:1500 cycles min.

2.Electrical Characteristics
 Contact resistance;
 Date Contact:150mΩ max
 CD Switch:500mΩ max
 Insulation resistance:>1000MΩ/500V DC

3.Solderability
 Vapor phase: 215°C,30sec.Max
 IR reflow: 250°C,5sec.Max
 Manual soldering: 370°C,3sec.Max

4.Environmental Characteristics
 Operating temperature: -40°C~+85°C
 Operating humidity:10%~+95%RH



Micro SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	COIL SPRING	1	SWP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	

Unless otherwise specified, other tolerance are:

X ±0.35	X' ±5'
X.X ±0.25	X.X' ±4'
X.XX ±0.15	X.XX' ±3'
X.XXX ±0.10	X.XXX' ±2'

PROJ. UNIT mm SCALE 1:1

CUSTOMER DRAWING

CONNECT MALL
T.1599-6885

NAME: **MicroSIM Card Connector**
 MODEL NO: **MSIMC-C79208**
 TYPE: **Normally CLOSE H1.50 8PIN**

DRAWN	DWG NO.:
CHECKED	
APPROVAL	
	SHEET 1/1
	REVISION X1